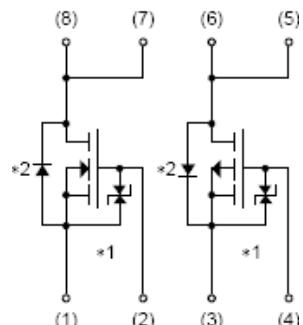


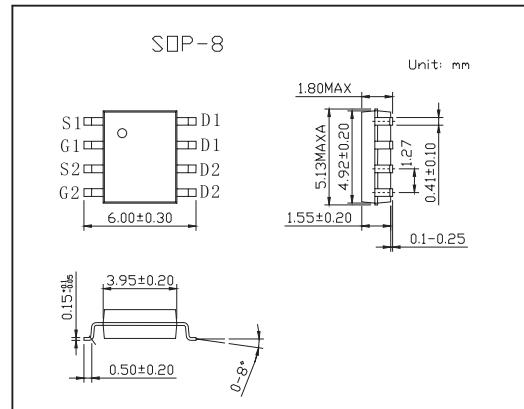
### ■ Features

- Low on-resistance.
- Built-in G-S Protection Diode.
- Small and Surface Mount Package.
- Power switching, DC / DC converter.



\*1 ESD PROTECTION DIODE

\*2 BODY DIODE



### ■ Absolute Maximum Ratings Ta = 25°C

Parameter	Symbol	N-Channel	P-Channel	Unit
Drain-source voltage	V <sub>DSS</sub>	30	-30	V
Gate-source voltage	V <sub>GSS</sub>	±20	±20	V
Drain current Continuous	I <sub>D</sub>	±7.0	±4.5	A
Drain current Pulsed *	I <sub>DP</sub>	±28	±18	A
Source current (Body diode) Continuous	I <sub>S</sub>	1.6	-1.6	A
Source current (Body diode) Pulsed *	I <sub>SP</sub>	6.4	-18	A
Total power dissipation (T <sub>c</sub> =25°C)	P <sub>D</sub>	2		W
Channel temperature	T <sub>ch</sub>	150		°C
Storage temperature	T <sub>stg</sub>	-55 to +150		°C
Channel to ambient	R <sub>th</sub> (ch-a)	62.5		°C/W

\* Pw≤10 μ s, Duty cycle≤1%

## ■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Testconditons		Min	Typ	Max	Unit	
Gate-source leakage	I <sub>GSS</sub>	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	N-Ch			±10	μ A	
		V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	P-Ch			±10		
Drain-source breakdown voltage	V <sub>(BR) DSS</sub>	I <sub>D</sub> =1mA, V <sub>GS</sub> =0V	N-Ch	30			V	
		I <sub>D</sub> =-1mA, V <sub>GS</sub> =0V	P-Ch	-30				
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V	N-Ch			1	μ A	
		V <sub>DS</sub> =-30V, V <sub>GS</sub> =0V	P-Ch			-1		
Gate threshold voltage	V <sub>GS (th)</sub>	V <sub>DS</sub> =10V, I <sub>D</sub> =1mA	N-Ch	1.0		2.5	V	
		V <sub>DS</sub> =-10V, I <sub>D</sub> =-1mA	P-Ch	-1.0		-2.5		
Static drain-source on-state resistance	R <sub>DSS (on)</sub>	I <sub>D</sub> =7.0A, V <sub>GS</sub> =10A	N-Ch		17	24	m Ω	
		I <sub>D</sub> =7.0A, V <sub>GS</sub> =4.5V			23	33		
		I <sub>D</sub> =7.0A, V <sub>GS</sub> =4V			25	35		
Static drain-source on-state resistance	R <sub>DSS (on)</sub>	I <sub>D</sub> =-4.5A, V <sub>GS</sub> =-10A	P-Ch		40	56	m Ω	
		I <sub>D</sub> =-4.5A, V <sub>GS</sub> =-4.5V			57	80		
		I <sub>D</sub> =-4.5A, V <sub>GS</sub> =-4.0V			65	90		
Forward transfer admittance	Y <sub>fs</sub>	I <sub>D</sub> =7.0A, V <sub>DS</sub> =10V	N-Ch	5.0			S	
		I <sub>D</sub> =-4.5A, V <sub>DS</sub> =-10V	P-Ch	3.5				
Input capacitance	C <sub>iss</sub>	N-Channel V <sub>DS</sub> =10V, V <sub>GS</sub> =0V, f=1MHz	N-Ch		600		pF	
			P-Ch		850			
Output capacitance	C <sub>oss</sub>		N-Ch		200		pF	
			P-Ch		190			
Reverse transfer capacitance	C <sub>rss</sub>	P-Channel V <sub>DS</sub> =-10V, V <sub>GS</sub> =0V, f=1MHz	N-Ch		120		pF	
			P-Ch		120			
Turn-on delay time	t <sub>d (on)</sub>	I <sub>D</sub> =3.5A, V <sub>DD</sub> =15V	N-Ch		8		ns	
		I <sub>D</sub> =-2.5A, V <sub>DD</sub> =-15V	P-Ch		10			
Rise time	t <sub>r</sub>	N-Channel V <sub>GS</sub> =10V, R <sub>L</sub> =4.29 Ω, R <sub>G</sub> =10 Ω	N-Ch		10		ns	
			P-Ch		25			
Turn-off delay time	t <sub>d (off)</sub>		N-Ch		37		ns	
			P-Ch		60			
Fall time	t <sub>f</sub>	P-Channel V <sub>GS</sub> =-10V, R <sub>L</sub> =6.0 Ω, R <sub>G</sub> =10 Ω	N-Ch		11		ns	
			P-Ch		25			
Total gate charge	Q <sub>g</sub>	N-Channel V <sub>DD</sub> =15V, V <sub>GS</sub> =5V, I <sub>D</sub> =7.0A	N-Ch		8.4	11.8	nC	
			P-Ch		8.5			
Gate-source charge	Q <sub>gs</sub>		N-Ch		1.9		nC	
			P-Ch		2.5			
Gate-drain charge	Q <sub>gd</sub>	P-Channel V <sub>DD</sub> =-15V, V <sub>GS</sub> =-5V, I <sub>D</sub> =-4.5A	N-Ch		3.3		nC	
			P-Ch		3.0			
Forward voltage	V <sub>SD</sub>	I <sub>S</sub> =6.4A, V <sub>GS</sub> =0V	N-Ch			1.2	V	
		I <sub>S</sub> =-1.6A, V <sub>GS</sub> =0V	P-Ch			-1.2		